

TAI-SAW TECHNOLOGY CO., LTD.

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Product Specifications Approval Sheet

Product Description: Crystal Unit SMD 2.0x1.6 50.0MHz

TST Part No.: TZ3208A (for B1484 only)

Customer Part No.: B1484

Customer signature re	equired	
Company:		
Division:		
Approved by :		
Date:		
Checked by:	Chivalry Lin	Chivalry
Approved by:	Kelly Huang	Kuly Huang
Date:	08/06/2018	

- 1. Customer signed back is required before TST can proceed with sample build and receive orders.
- 2. Orders received without customer signed back will be regarded as agreement on the specifications.
- 3. Any specifications changes must be approved upon by both parties and a new revision of specifications shall be released to reflect the changes.

TAI-SAW TECHNOLOGY CO., LTD. Crystal Unit SMD 2.0x1.6 50.0MHz

MODEL NO.: TZ3208A

REV. NO.: 3

Revise:

Rev.	Rev. Page	Rev. Account	Date	Ref. No.	Revised by
1	N/A	Initial release	12/22/16'	N/A	Chivalry Lin
2.	5	Change Marking Rule	07/11/17'	ECN-201700285	Chivalry Lin
3	3	Change Tolerance to 5+/-20 ppm	08/06/18'	ECN-201800344	Chivalry Lin
	1				

TST DCC Release document

TAI-SAW TECHNOLOGY CO., LTD. Crystal Unit SMD 2.0x1.6 50.0MHz

MODEL NO.: TZ3208A

REV. NO.: 3

3/8

Features:

- Surface Mount Hermetic Package •
- **Excellent Reliability Performance** •
- Good Frequency Perturbation and Stability over temperature •
- Ultra Miniature Package •
- Moisture Sensitivity Level (MSL) : Level-1 •

Description and Applications:

Surface mount 2.0mmx1.6mm crystal unit for use in wireless communications devices, especially for a need of ultra miniature package for mobility.

Electrical Specifications:

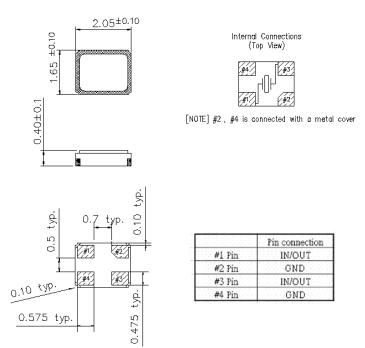
TZ3208A	Specification	Specification					
Nominal Frequency	50.000000 MHz	50.000000 MHz					
Mode of Oscillation	Fundamental						
Storage Temperature Range	-55°C to +125°C						
Operating Temperature Range	-35°C to +85°C						
Frequency Stability over Operating Temperature Range	+/-20 ppm (referred	to the value at 25°C)					
Frequency Make Tolerance (FL)	5+/-20 ppm @ 25°C	+/- 3°C					
Equivalent Series Resistance (ESR)	60 Ω max	60 Ω max					
Nominal Drive Level	10uW typical and 10	10uW typical and 100uW max					
ESR Change due to Drive Level:	5Ω Max,1uW-100u	5Ω Max,1uW-100uW					
Frequency Shift due to Drive Level:	5ppm Max,1uW-100	5ppm Max,1uW-100uW					
Shunt Capacitance (Co)	1.8 pF max	1.8 pF max					
Load Capacitance (CL)	14 pF	14 pF					
Aging	+/-3ppm/year	+/-3ppm/year					
Insulation Resistance	500 MΩ min./DC 10	500 MΩ min./DC 100V					
Marking	Laser Marking	Laser Marking					
Unit Weight	5.7mg+/-0.5mg	5.7mg+/-0.5mg					
TAI-SAV	W TECHNOLOGY CO., LTD.	TST DCC					

Release document

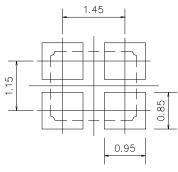
RoHS Compliant

Lead free Lead-free soldering

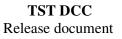
Mechanical Dimensions (mm): Base



Recommended Land Pattern: (unit: mm)

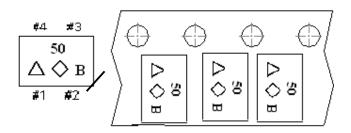


Recommended Land Pattren



Marking:

Line 1: Frequency (50) Line 2: Date Code (\triangle) + Year Code(\diamondsuit)+ Product Code(B)



\triangle : Date Code Table:

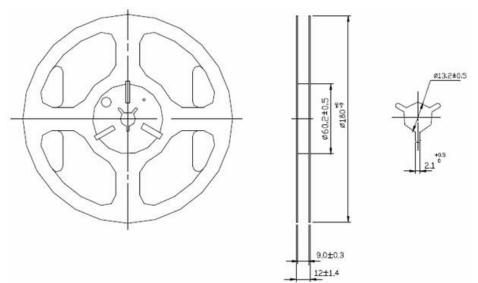
WK01	WK02	WK03	WK04	WK05	WK06	WK07	WK08	WK09	WK10	WK11	WK12	WK13
Α	В	С	D	E	F	G	Н	1	J	К	L	М
WK14	WK15	WK16	WK17	WK18	WK19	WK20	WK21	WK22	WK23	WK24	WK25	WK26
N	0	Р	Q	R	S	Т	U	V	W	Х	Y	Z
WK27	WK28	WK29	WK30	WK31	WK32	WK33	WK34	WK35	WK36	WK37	WK38	WK39
a	b	с	d	е	f	g	h	i	j	k	I	m
WK40	WK41	WK42	WK43	WK44	WK45	WK46	WK47	WK48	WK49	WK50	WK51	WK52
n	0	p			s		u	v	w	х		-

\diamondsuit :Year Code Table :

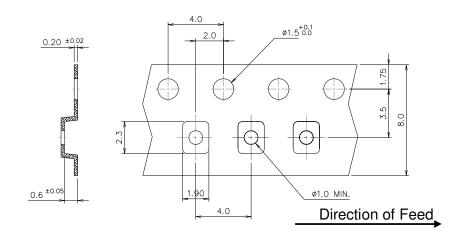
Year	2017	2018	2019	2020	2021	2022	2023	2024	2025	2026
Code	Α	В	С	D	E	F	G	Н		J
Year	2027	2028	2029	2030	2031	2032	2033	2034	2035	2036
Code	К	L	M	N	0	Р	Q	R	S	Т
Year	2037	2038	2039	2040	2041	2042				
Code	U	V	W	Х	Y	Z				

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Reel Dimensions (mm):



Tape Dimensions (mm):

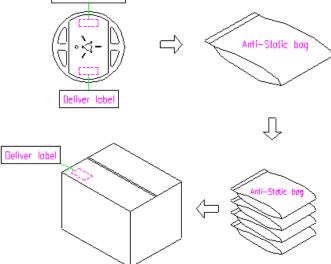


[NOTE]:

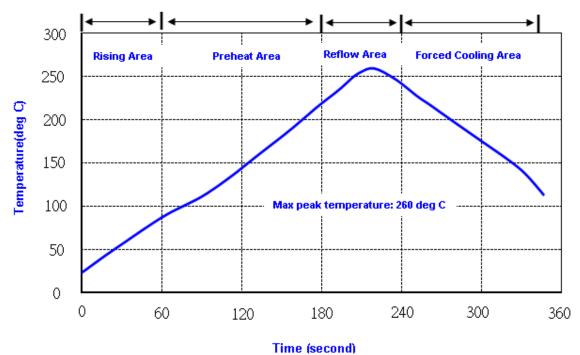
- 1. Unless otherwise specified tolerance on dimension +/-0.1 mm.
- 2. Material: conductive polystyrene with color black.
- 3. 10 pitch cumulative tolerance +/-0.2 mm.

Packing Quantity/Packing: 3K pcs maximum per reel





Reflow Profile:



Note: 1.Max peak temperature: 260+/-5 deg C; Time: 10+/-2 sec 2. Temperature: 217+/-5 deg C; Time: 90~100 sec

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Reliability Specifications

Test name	Test process / method	Reference standard							
Mechanical characteristics									
resistance to Soldering heat (IR reflow)	Temp./ Duration : 265°C /10sec ×2 times Total time : 4min.(IR-reflow)	EIAJED-4701 -300(301)M(II)							
Vibration	Total peak amplitude : 1.5mmVibration frequency: 10 to 2000 HzSweep period: 20 minuteVibration directions: 3 mutually perpendicularDuration: 2 hr / direc.	MIL-STD 202G method 204							
Mechanical Shock	directions : 3 impacts per axis Acceleration : 3000g's, +20/-0 % Duration : 0.3 ms (total 18 shocks) Waveform : Half-sine	MIL-STD 202G method 213							
Solderability	Solder Temperature:265±5℃ Duration time: 5±0.5 seconds.	J-STD-002							
Environmental	characteristics								
Thermal Shock	Heat cycle conditions -40 °C (30min) ←→ 85 °C (30min) * cycle time : 10 times	MIL-STD 883G method 1010.8							
Humidity test	Temperature : 85 ± 2 °C Relative humidity : 85% Duration : 96 hours	MIL-STD 202G method 103							
Dry heat (Aging test)	Temperature : 125 ± 2 ℃ Duration : 168 hours	MIL-STD 202G method 108A							
Cold resistance (Low Temp Storage)	Temperature :-40 ± 2 ℃ Duration : 96 hours	IEC 60068-2-1							